

Customer Information Notification

Issue Date: 12-Jun-2019 **Effective Date:** 13-Jun-2019

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.

2019050331



Change Category				
[] Wafer Fab Process] Assembly	[] Product Marking	[] Test	[] Design
Р	rocess		Location	
[] Wafer Fab Materials] Assembly	[] Mechanical Specification	ı[]Test	[] Errata
M	1aterials		Process	
[] Wafer Fab Location] Assembly	[]	[] Test	[] Electrica
Le	ocation	Packing/Shipping/Labeling	Equipment	spec./Test
				coverage

[] Firmware [X] Other - Safety Manual

MC33771A, MC33771B, SC33772A, MC33772B Safety Manual Updates

Description

NXP Semiconductors announces Safety Manual updates for the Battery Cell Controller IC products associated with this notification. The revision history included in the updated documents provides a detailed description of the changes.

Among the changes, NXP would like to especially highlight the following items that avoid having, under certain application conditions, false alarms when running diagnostics.

Please see the attached summary for all changed items.

Reference / Description

- SysRec 10 added: Cyclic conversion disabling before going to Diagnostic Mode
- SysRec 12 added: Reminder to disable Cell Balance before measuring cell voltages
- SM08 updated: Add SW deglitching of the clock frequency fault flag
- SM40 updated: Add a command in the SM40 sequence

Safety Manuals have been updated as follows:

MC33771A updated to Safety Manual Revision O

MC33771B updated to Safety Manual Revision D

SC33772A updated to Safety Manual Revision J

MC33772B updated to Safety Manual Revision D

New Safety Manual documents can be retrieved from NXP DocStore at: www.docstore.nxp.com

Corresponding ZVEI Delta Qualification matrix ID: SEM-DS-02

Reason

To announce the release of updated versions of Battery Cell Controller IC Safety Manuals - see attached for details. **Identification of Affected Products**

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

View Notification	Subscription	Support
-------------------	--------------	---------

NXP | Privacy Policy | Terms of Use

NXP Semiconductors

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.

Affected Part Number	Changed Part 12NC
MC33771BSP1AE	935349661557
MC33771BTA1AE	935350632557
MC33772BTC0AE	935363206557
MC33772BSP1AE	935358985557
MC33772BTP1AE	935359123557
MC33771BTP1AE	935350893557